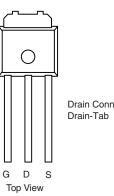


# VSI050P10MS-VB Datasheet P-Channel 100 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	- 100			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.033			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 V$	0.037			
I <sub>D</sub> (A)	- 40			
Configuration	Single			



#### TO-251

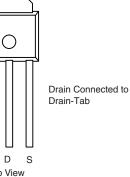
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET

S

- Package with Low Thermal Resistance
- 100 %  $R_g$  and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





# GC P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25$ °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage		V <sub>DS</sub>	- 100	v		
Gate-Source Voltage		V <sub>GS</sub>	± 20			
Continuous Drain Current	T <sub>C</sub> = 25 °C	1	- 40			
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	- 22			
Continuous Source Current (Diode Conducti	I <sub>S</sub>	- 50	A			
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	- 150				
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 44			
Single Pulse Avalanche Energy	L = 0.1 MH	E <sub>AS</sub>	96	mJ		
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	PD	136	w		
	T <sub>C</sub> = 125 °C	ГD	45	vv l		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W		
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.1	0/₩		

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Parametric verification ongoing.

<b>SPECIFICATIONS</b> ( $T_c = 25 \text{ °C}$ , unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 100	-	-	V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$		-	-2.5		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$		I	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 100 V	-	-	- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS}$ = - 100 V, $T_{J}$ = 125 $^{\circ}C$	-	-	- 50	μA	
		$V_{GS} = 0 V$	$V_{DS}$ = - 100 V, $T_{J}$ = 175 $^{\circ}C$	-	-	- 250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS}$ = - 10 V	$V_{DS} \le$ - 5 V	- 30	-	-	А	
		$V_{GS} = -10 V$	I <sub>D</sub> = - 9.2 A	-	0.033	-	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS}$ = - 10 V	$I_D$ = - 9.2 A, $T_J$ = 125 °C	-	0.074	-		
Diain-Source On-State Resistance"	US(on)	$V_{GS}$ = - 10 V	$I_D$ = - 9.2 A, $T_J$ = 175 °C	-	0.093	-		
		$V_{GS} = -4.5 V$	I <sub>D</sub> = - 7.7 A	-	0.037	-		
Forward Transconductanceb	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -9.2 \text{ A}$		-	35	-	S	
Dynamic <sup>b</sup>								
Input Capacitance	C <sub>iss</sub>		V V <sub>DS</sub> = - 25 V, f = 1 MHz	-	4433	5545	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	301	380		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	208	260		
Total Gate Charge <sup>c</sup>	Qg				96	144		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = -10 V$	$V_{DS} = -50V, I_{D} = -9.2 \text{ A}$	-	8.4	-	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>				23.5	-	1	
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.5	3.13	4.7	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD} = -50 \text{ V}, \text{ R}_{\text{L}} = 6.49 \Omega$ $\text{I}_{\text{D}} \cong -7.7 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 1.0 \Omega$		-	11	17	ns	
Rise Time <sup>c</sup>	t <sub>r</sub>			-	11	17		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	78	117		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	15	23		
Source-Drain Diode Ratings and Characteristics <sup>b</sup>								
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	- 150	Α	
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = - 7.7 A, V <sub>GS</sub> = 0 V		-	- 0.8	- 1.5	V	

#### Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

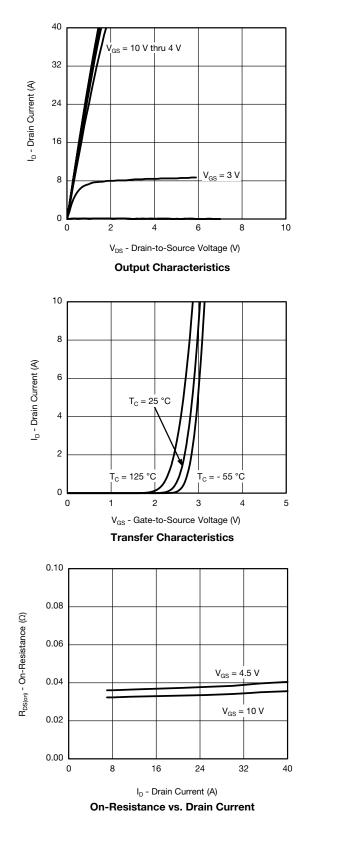
c. Independent of operating temperature.

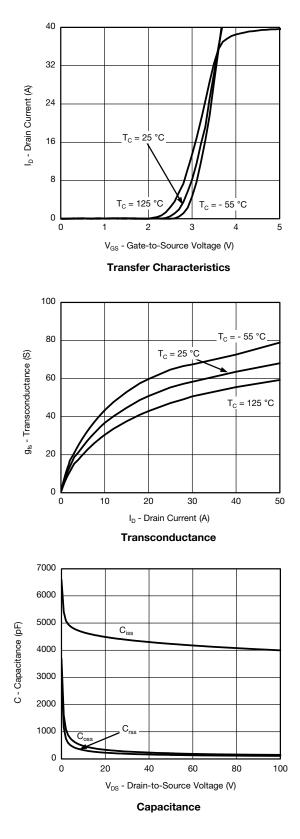
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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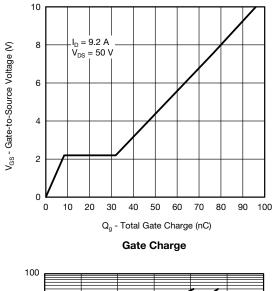
#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)

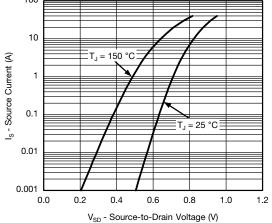




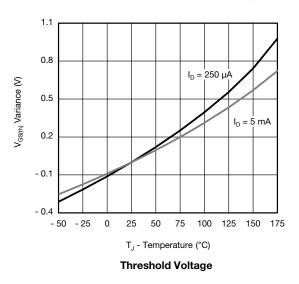


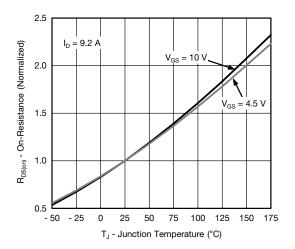
#### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



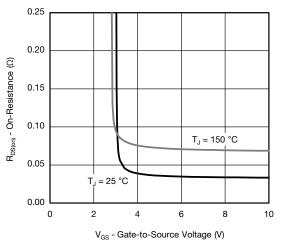


Source Drain Diode Forward Voltage

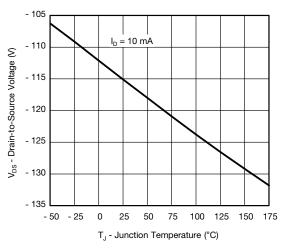




**On-Resistance vs. Junction Temperature** 



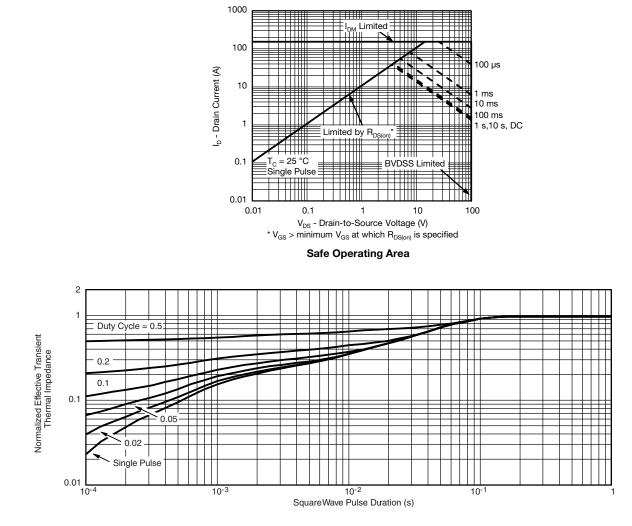
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



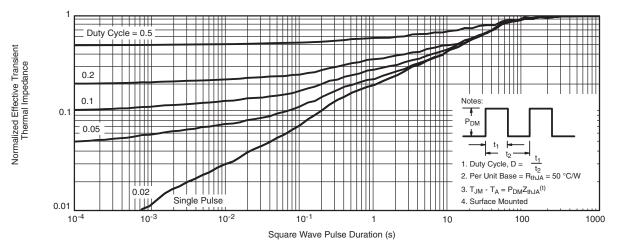
#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



#### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

#### Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction to Ambient (25 °C)

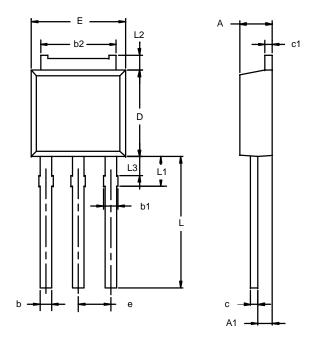
- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

### VSI050P10MS-VB



#### **TO-251AA**



	MILLIMETERS		INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090	BSC	
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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